	FLH Ref. No.: 450100-0341
08-28-2	∠UU I T U.S. DEPARTMENT OF COMMERCE
	Patent and Trademark Office
To the Honorable Commissioner of Patr 101825	ached original documents or copy therec
1. Name of conveying party(ies)	2. Name and address of receiving party(ies)
Manabu OBATA, Mitsungri MATSUMURA	Name: SONY CORPORATION 7-35 Kitashinagawa 6-chome Shinagawa-Ku, Tokyo 141-0001, Japan
Additional name(s) of conveying party(ies) attached? — Yes <u>X</u> No	Additional name(s) & address(es) attached? Yes _x_
3. Nature of conveyance:	0
X Assignment Security Agreement Merger Change of Name Other	931707
Execution Date: <u>July 18, 2001</u>	60
4. Application number(s) or patent number(s):	1931707
If this document is being filed together fit the application is: <u>July 18, 2001</u>	h a new application, the execution date of
A. Patent Application No.(s) filed	
Additional numbers atta	ached? Yes _X_ No
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved 1
Name: WILLIAM S. FROMMER	7. Total fee (37 CFR 3.41)
Internal Address: FROMMER LAWRENCE & HAUG LLP	X Enclosed Authorized to be charged to deposit account 50-0320
Street Address: 745 FIFTH AVENUE	a Provide account pumber:
City: <u>NEW YORK</u> State: <u>N.Y.</u> Zip: 10151	(Attach duplicate copy of this page if paying by deposit account)
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9. Statement and signature.	continuo is true and correct and any attached copy is a true cop
 Statement and Signature. To the best of my knowledge and belief, the foregoing info of the original document. 	ormation is true and correct and any attached copy is a true cop
of the original documents	August 16, 2001
William S. Frommer Stg	Date Total number of pages including cover
Name of Person Signing	sheet, attachments, and document: 2
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Washington, D.C. 20231 1 FC:581 40.00 DP Washington, D.C. 20231 Washington, D.C. 20231 Public burden reporting for this sample cover sheet is estimated to average about 30 minutes per document to be recorded, and completing and reviewing the sample cover sheet is estimated to average about 30 minutes per document to be recorded, and completing and reviewing the sample cover sheet is estimated to average about 30 minutes per document to be recorded, and completing and reviewing the sample cover sheet is estimated to average about 30 minutes per document to be recorded, and completing and reviewing the document and gathering the data needed, and completing and reviewing the document and gathering the data needed, and completing and reviewing the document and gathering the data needed, and completing and reviewing the sample cover sheet is estimated to average about 30 minutes per document to be recorded, and completing and reviewing the sample cover sheet is estimated to average about 30 minutes per document to be recorded, and completing and reviewing the sample cover sheet is estimated to average about 30 minutes per document to be recorded, and completing and reviewing the document and gathering the data needed, and completing and reviewing the document and gathering the data needed, and completing the document and gathering the data needed.	
Public burden reporting for this sample cover sheet is estimate including time for reviewing the document and gathering the country send comments regarding this burden estimate to the U.S. Pater Send comments regarding this burden estimate to the U.S. Pater Send comments regarding this burden estimate to the U.S. Pater Send Comments and Send Send Send Send Send Send Send Se	ated to average about 30 minutes per document to be readers sheet data needed, and completing and reviewing the sample cover sheet ent and Trademark Office, Office of Information Systems, gement and Budget, Paperwork Reduction Project (0651-0011),
PK2-1000C, Washington, D.C. 20231, and Washington, D.C. 20503.	

CMS Docket Number:

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in DISK CARTRIDGE, A METHOD OF MANUFACTURING SAME, AND A RECORDING/REPRODUCING SYSTEM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing

And I hereby authorize and request my attended at a special number:	Filing Date:
This assignment executed on the dates indicated	below.
MANABU OBATA	Execution date of U.S. Patent Application
Name of first or sole inventor KANAGAWA, JAPAN	
Residence of first or sole inventor Manalu Obata	Date of this assignment
Signature of first or sole inventor	
MITSUNORI MATSUMURA	Execution date of U.S. Patent Application
Name of second inventor TOKYO, JAPAN	F1 0 220/
Residence of second inventor Mutsumori Matsumura Signature of second inventor	Date of this assignment
Name of third inventor	Execution date of U.S. Patent Application
Residence of third inventor	
Signature of third inventor	Date of this assignment

RECORDED: 08/16/2001

PATENT REEL: 012099 FRAME: 0856